

## FEATURES

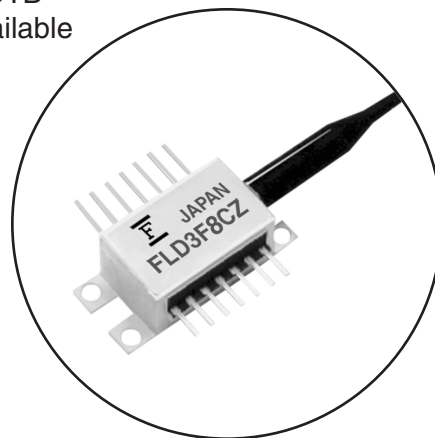
- Direct Modulation MQW DFB Laser
- Built-in TEC, Thermistor and Monitor PD
- Optical Isolator
- 14-Pin Butterfly Type Module

## BENEFITS

- 78 Channel NTSC Loading (112 Channel device available)
- Low Residual CSO & CTB
- 5.5 dB Link Budget Available
- Suitable for Narrow Cast Configuration

## APPLICATIONS

This MQW DFB laser is intended for application in analog AM, CATV at 1,310nm. Transmission spans of 15 km are possible without amplification.



## DESCRIPTION

This MQW (Multiple Quantum Well) DFB laser for analog AM application is a middle power laser capable of carrying 78 channels with excellent CSO, CTB, and CNR performance. It is packaged in a 'butterfly' type module. The module employs a cost effective optical coupling system, coupling the laser output through a built-in optical isolator into a single mode fiber pigtail. The module also includes a monitor photodiode, a thermoelectric cooler (TEC) and a thermistor.

## ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub>=25°C)

| Parameter                  | Symbol           | Ratings    | Unit |
|----------------------------|------------------|------------|------|
| Storage Temperature        | T <sub>stg</sub> | -40 to +70 | °C   |
| Operating Case Temperature | T <sub>op</sub>  | -20 to +65 | °C   |
| Optical Output Power       | P <sub>f</sub>   | 8          | mW   |
| Laser Forward Current      | I <sub>F</sub>   | 150        | mA   |
| Laser Reverse Voltage      | V <sub>R</sub>   | 2          | V    |
| Photodiode Reverse Voltage | V <sub>DR</sub>  | 20         | V    |
| TEC Voltage                | V <sub>C</sub>   | 2.5        | V    |
| TEC Current                | I <sub>C</sub>   | 1.4        | A    |

## TEC AND THERMISTOR CHARACTERISTICS ( $T_L=25\pm1^\circ\text{C}$ )

| Parameter             | Symbol     | Limit      |      | Unit             | Test Conditions             |
|-----------------------|------------|------------|------|------------------|-----------------------------|
|                       |            | Min.       | Max. |                  |                             |
| TEC Current           | $I_C$      | -          | 1.0  | A                | $\Delta T=40^\circ\text{C}$ |
| TEC Voltage           | $V_C$      | -          | 2.0  | V                | $\Delta T=40^\circ\text{C}$ |
| TEC Capacity          | $\Delta T$ | 40         | -    | $^\circ\text{C}$ | $I_C=1\text{A}$             |
| Thermistor Resistance | $R_{tr}$   | 9.5        | 10.5 | $\text{k}\Omega$ | -                           |
| Thermistor B Constant | B          | typ. 3,900 |      | K                | -                           |

$T_C$ =Case Temperature,  $T_L$ =Laser Temperature

## OPTICAL AND ELECTRICAL CHARACTERISTICS ( $T_L=25\pm1^\circ\text{C}$ )

| Parameter                  | Symbol      | Limits |       | Unit          | Conditions                            |
|----------------------------|-------------|--------|-------|---------------|---------------------------------------|
|                            |             | Min.   | Max.  |               |                                       |
| Threshold Current          | $I_{th}$    | -      | 20    | mA            | CW                                    |
| Forward Voltage (pin 3-13) | $V_F$       | -      | 1.5   | V             | CW, $I_F=I_{op}$                      |
| Optical Output Power       | $P_f$       | 2      | 4     | mW            | CW, $I_F=I_{op}$                      |
| Slope Efficiency           | S           | 0.08   | -     | mW/mA         | CW, $I_F=I_{op}$                      |
| Monitor Current            | $I_m$       | 30     | 900   | $\mu\text{A}$ | CW, $I_F=I_{op}$ , $V_{DR}=5\text{V}$ |
| Photodiode Dark Current    | $I_d$       | -      | 100   | nA            | $V_{DR}=5\text{V}$                    |
| Photodiode Capacitance     | $C_t$       | -      | 12    | pF            | $V_{DR}=5\text{V}$ , $f=1\text{MHz}$  |
| Peak Wavelength            | $\lambda_p$ | 1,290  | 1,330 | nm            | CW, $I_F=I_{op}$                      |
| SideMode Suppression Ratio | SSR         | 25     | -     | dB            | CW, $I_F=I_{op}$                      |
| Bandwidth (-1dB)           | $f_c$       | 1.5    | -     | GHz           | Note (2)                              |
| Isolation                  | $I_s$       | 25     | -     | dB            | $T_c=0$ to $65^\circ\text{C}$         |
| Relative Intensity Noise   | RIN         | -      | -155  | dB/Hz         | Note (3)                              |
| Composite Second Power     | CSO         | -      | -57   | dBc           | Note (4)                              |
| Composite Triple Beat      | CTB         | -      | -65   | dBc           |                                       |
| Carrier to Noise Ratio     | CNR         | 50     | -     | dB            |                                       |

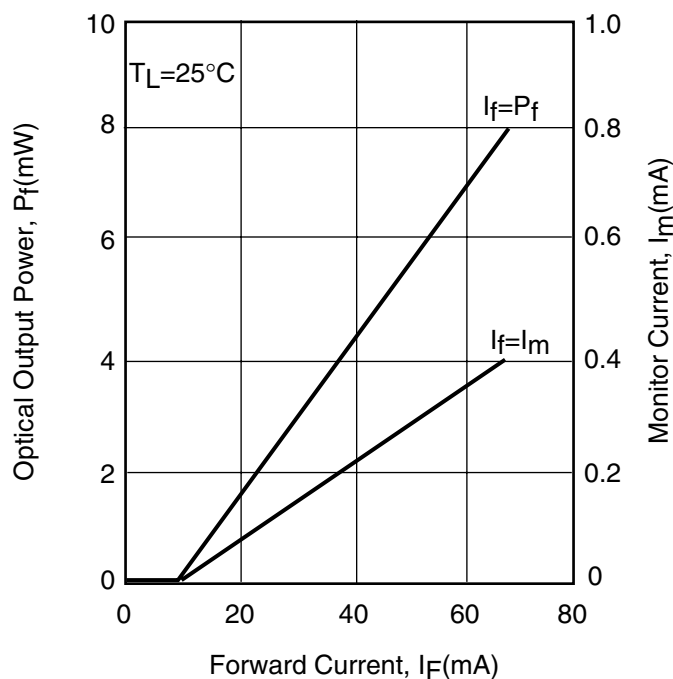
(1) Total change in  $P_f$  over  $-20<T_c<+65^\circ\text{C}$ , Test conditions:  $P_f=4\text{mW}$  at  $T_L=T_c=25^\circ\text{C}$ . Constant current operation with TEC operating.

(2) Test condition:  $P_f=4\text{mW}$ , No matching network is used in the measurement.

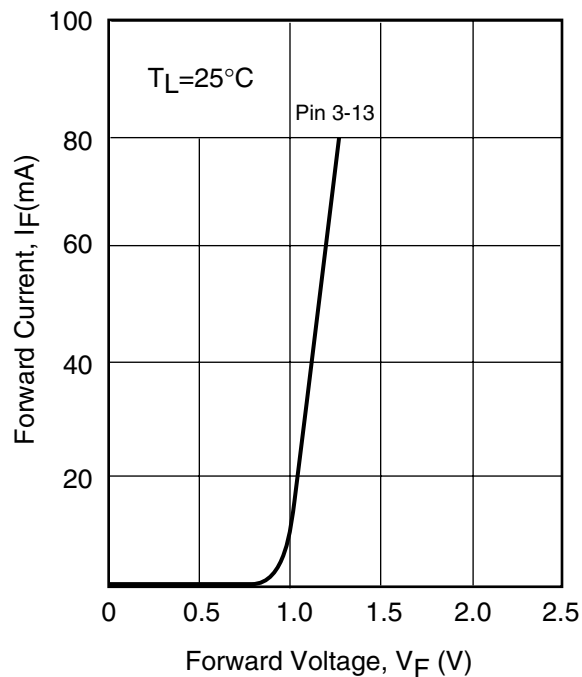
(3) Test condition:  $P_f$ ; same power of Note 4, measuring bandwidth: 45-600MHz, Optical reflection=-40dB (no long-haul fiber is used in the measurement.)

(4) Test condition:  $P_f=2\text{mW}$  (minimum) to  $4\text{mW}$  (maximum), Optical Modulation, Index=3.2% channel (minimum), 78 unmodulated carriers (55.25 to 547.25 MHz; ch. 2 to 78 plus A-1), Optical link loss=5.5 dB (15 km singlemode fiber), Noise equivalent current of 1st stage of the receiver= $7\text{pA}/\sqrt{\text{Hz}}$ , Receiver responsivity=0.86m/W, Optical reflection=-40dB (excluding reflection from long-haul fiber).

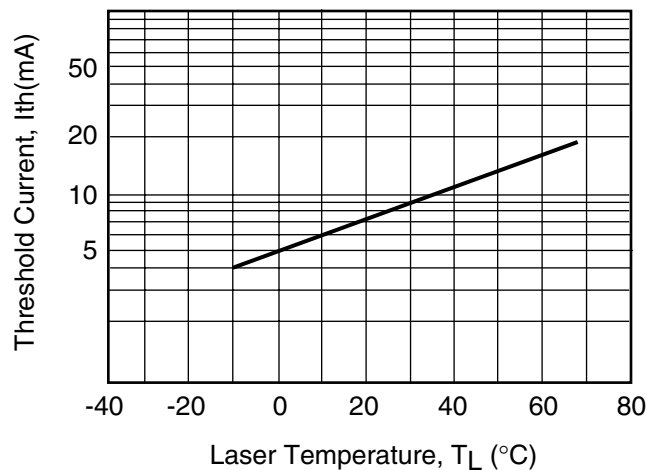
**Fig. 1 Optical Output Power and Monitor Current vs. Laser Forward Current**



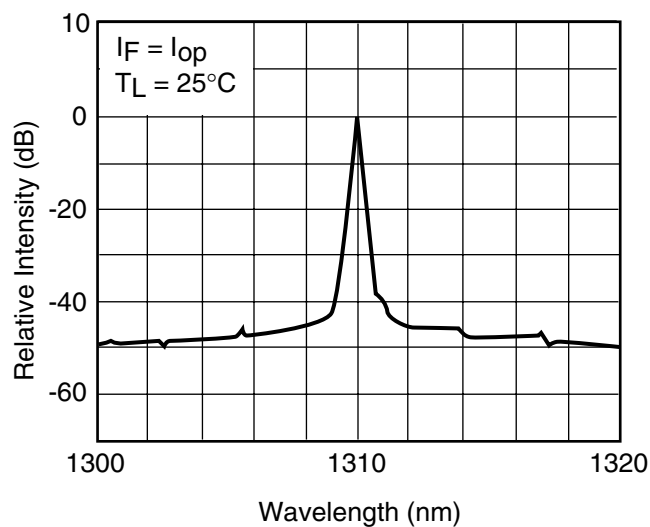
**Fig. 2 Forward Current vs. Forward Voltage**



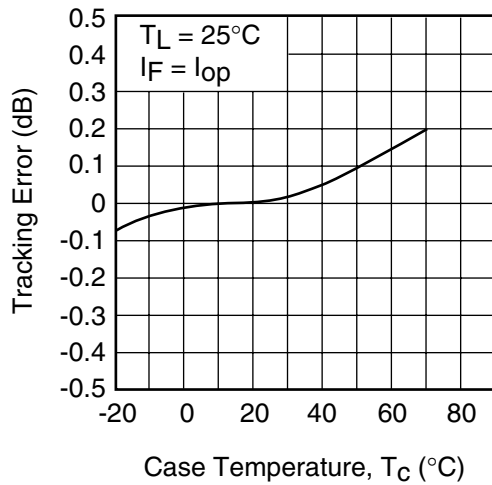
**Fig. 3 Temperature Dependence of Threshold Current**



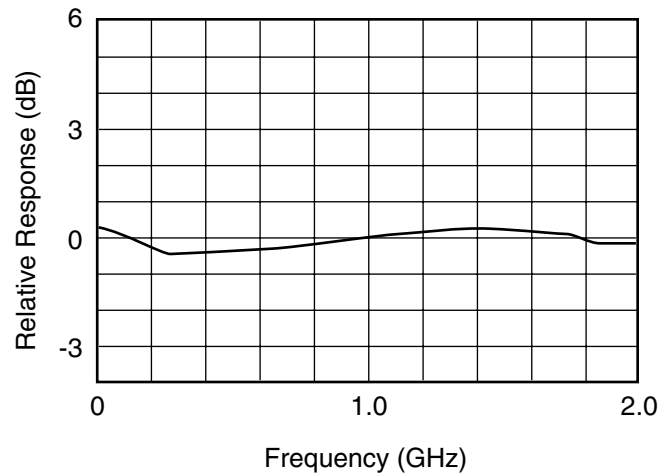
**Fig. 4 Lasing Spectrum**



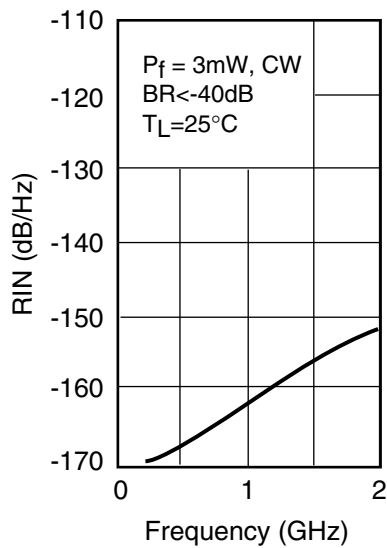
**Fig. 5 Tracking Characteristics**



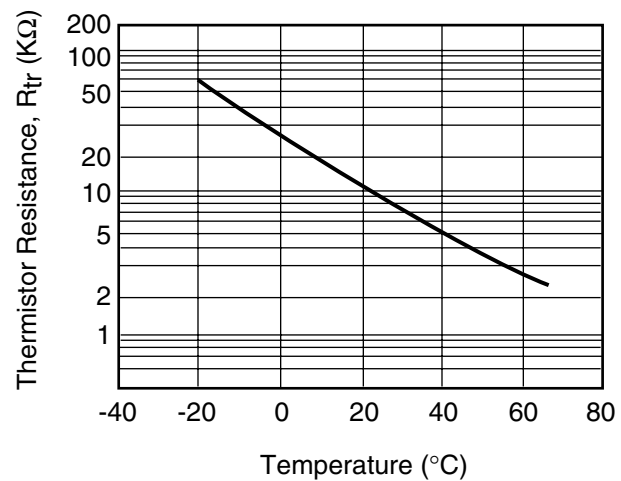
**Fig. 6 Frequency Response**



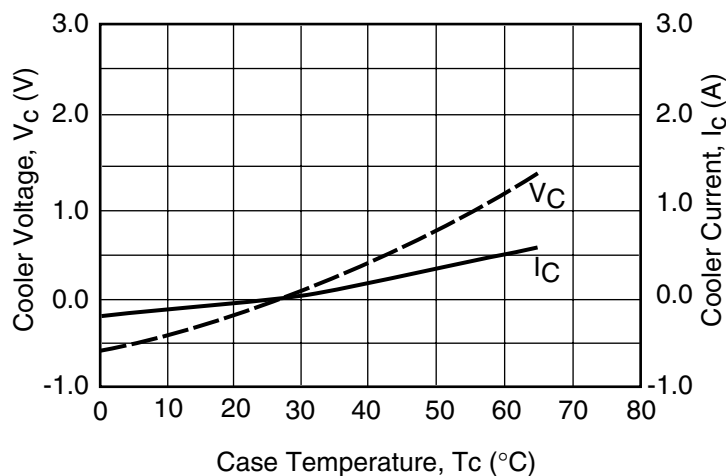
**Fig. 7 RIN Characteristics**



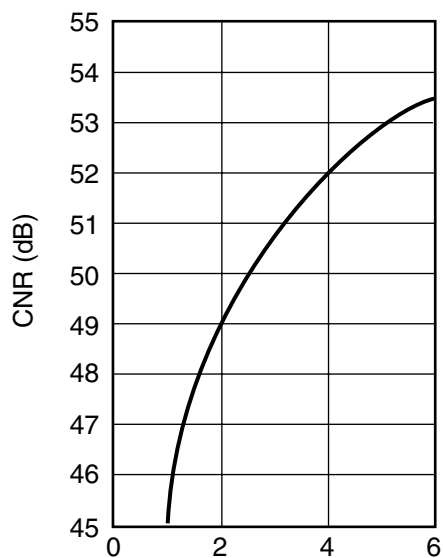
**Fig. 8 Thermistor Resistance vs. Temperature**



**Fig. 9 Cooler voltage and Cooler Current  
vs. Case Temperature**



**Fig. 10 CNR vs. Output Power**



Optical Output Power,  $P_f$  (mW)

NTSC-78ch  
OMI=4.0%/ch (Typ.)  
Link Loss=5.5dB (15km Single Mode Fiber)  
Noise Equivalent Current of Receiver,  $I_{eq}=7\text{pA}/\sqrt{\text{Hz}}$   
Sensitivity of PIN=0.86A/W

**Fig. 11 CSO and CTB vs. Output Power**

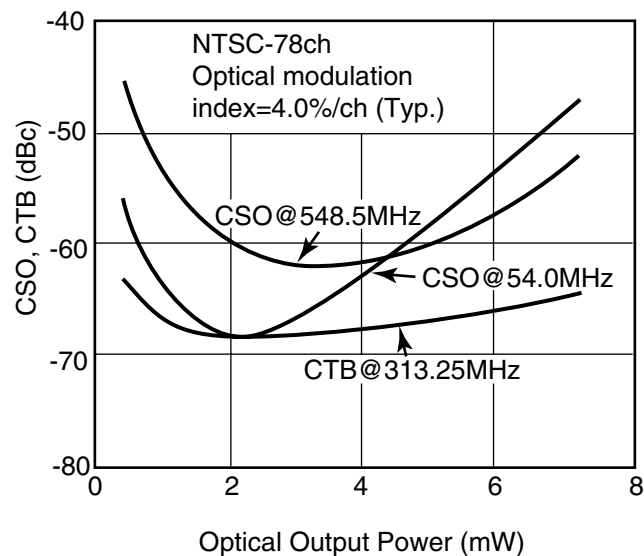
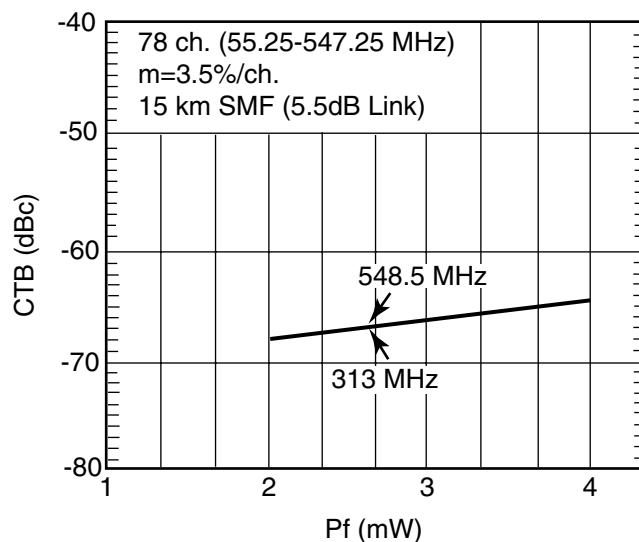
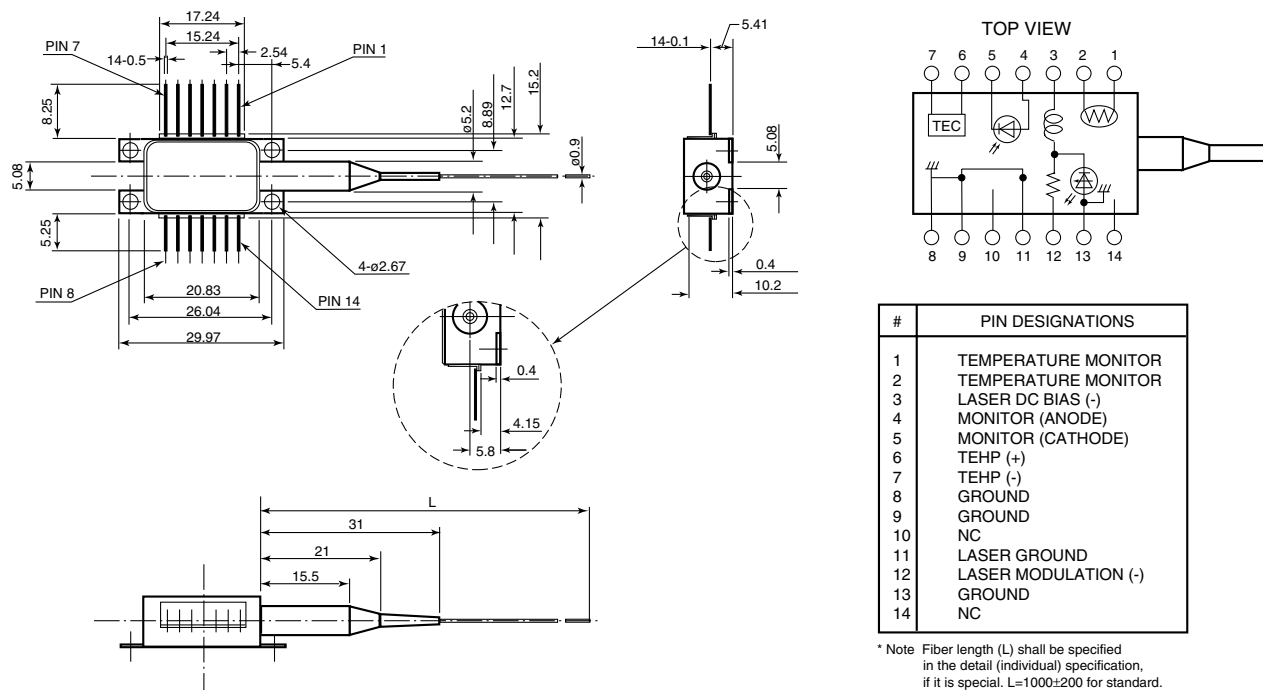


Fig. 12 Output Power vs. CTB



## "CZ" PACKAGE

UNIT: mm



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